

Special Issue

The High Efficiency Machining Process and Machining of Complex Materials

Message from the Guest Editors

This Special Issue is open to advances in the following two aspects: the improvement of the efficiency of the machining processes and the advancement of the use of complex materials in the machining process, involving the following:

- An improved, efficient machining process (conventional and non-conventional);
- A new, high-efficiency machining process;
- Traditional machining applied to complex materials;
- New machining processes applied to complex materials;
- Improved, efficient machining of complex materials;
- The application of a KET to improve the machining process;
- New tools, new characterization methods, and tool wear control;
- An adaptive machining process;
- Improvement of the performance of the machining process;
- A hybrid machining process.

Guest Editors

Dr. Moises Batista

Dr. Severo Raul Fernandez-Vidal

Dr. Jorge Salguero

Prof. Dr. Joao Paulo Davim

Deadline for manuscript submissions

closed (31 December 2019)



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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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